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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, Power Control PWM, QEI, POR, PWM, WDT
Number of I/O	24
Program Memory Size	8KB (4K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f2331-i-sp

1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- | | |
|--------------|---------------|
| • PIC18F2331 | • PIC18LF2331 |
| • PIC18F2431 | • PIC18LF2431 |
| • PIC18F4331 | • PIC18LF4331 |
| • PIC18F4431 | • PIC18LF4431 |

This family offers the advantages of all PIC18 microcontrollers – namely, high computational performance at an economical price, with the addition of high-endurance enhanced Flash program memory and a high-speed 10-bit A/D Converter. On top of these features, the PIC18F2331/2431/4331/4431 family introduces design enhancements that make these microcontrollers a logical choice for many high-performance, power control and motor control applications. These special peripherals include:

- 14-Bit Resolution Power Control PWM module (PCPWM) with Programmable Dead-Time Insertion
- Motion Feedback Module (MFM), including a 3-Channel Input Capture (IC) module and Quadrature Encoder Interface (QEI)
- High-Speed 10-Bit A/D Converter (HSADC)

The PCPWM can generate up to eight complementary PWM outputs with dead-band time insertion. Overdrive current is detected by off-chip analog comparators or the digital Fault inputs (FLTA, FLTB).

The MFM Quadrature Encoder Interface provides precise rotor position feedback and/or velocity measurement. The MFM 3x input capture or external interrupts can be used to detect the rotor state for electrically commutated motor applications using Hall sensor feedback, such as BLDC motor drives.

PIC18F2331/2431/4331/4431 devices also feature Flash program memory and an internal RC oscillator with built-in LP modes.

1.1 New Core Features

1.1.1 nanoWatt Technology

All of the devices in the PIC18F2331/2431/4331/4431 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- **Alternate Run Modes:** By clocking the controller from the Timer1 source or the internal oscillator block, power consumption during code execution can be reduced by as much as 90%.
- **Multiple Idle Modes:** The controller can also run with its CPU core disabled, but the peripherals are still active. In these states, power consumption can be reduced even further, to as little as 4% of normal operation requirements.

- **On-the-Fly Mode Switching:** The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- **Lower Consumption in Key Modules:** The power requirements for both Timer1 and the Watchdog Timer have been reduced by up to 80%, with typical values of 1.1 and 2.1 μ A, respectively.

1.1.2 MULTIPLE OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F2331/2431/4331/4431 family offer nine different oscillator options, allowing users a wide range of choices in developing application hardware. These include:

- Four Crystal modes, using crystals or ceramic resonators.
- Two External Clock modes, offering the option of using two pins (oscillator input and a divide-by-4 clock output) or one pin (oscillator input, with the second pin reassigned as general I/O).
- Two External RC Oscillator modes, with the same pin options as the External Clock modes.
- An internal oscillator block, which provides an 8 MHz clock and an INTRC source (approximately 31 kHz, stable over temperature and VDD), as well as a range of 6 user-selectable clock frequencies (from 125 kHz to 4 MHz) for a total of 8 clock frequencies.
- A Phase Lock Loop (PLL) frequency multiplier, available to both the High-Speed Crystal and Internal Oscillator modes, which allows clock speeds of up to 40 MHz. Used with the internal oscillator, the PLL gives users a complete selection of clock speeds, from 31 kHz to 32 MHz – all without using an external crystal or clock circuit.
- **Fail-Safe Clock Monitor:** This option constantly monitors the main clock source against a reference signal provided by the internal oscillator. If a clock failure occurs, the controller is switched to the internal oscillator block, allowing for continued low-speed operation or a safe application shutdown.
- **Two-Speed Start-up:** This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.

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6.5.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. A list of these registers is given in Table 6-1 and Table 6-2.

The SFRs can be classified into two sets: those associated with the “core” function and those related to the peripheral functions. Those registers related to the

“core” are described in this section, while those related to the operation of the peripheral features are described in the section of that peripheral feature.

The SFRs are typically distributed among the peripherals whose functions they control.

The unused SFR locations will be unimplemented and read as ‘0’s.

TABLE 6-1: SPECIAL FUNCTION REGISTER MAP FOR PIC18F2331/2431/4331/4431 DEVICES

Address	Name	Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FDFh	INDF2 ⁽¹⁾	FBFh	CCPR1H	F9Fh	IPR1	F7Fh	PTCON0
FFEh	TOSH	FDEh	POSTINC2 ⁽¹⁾	FBEh	CCPR1L	F9Eh	PIR1	F7Eh	PTCON1
FFDh	TOSL	FDDh	POSTDEC2 ⁽¹⁾	FBDh	CCP1CON	F9Dh	PIE1	F7Dh	PTMRL
FFCh	STKPTR	FDCh	PREINC2 ⁽¹⁾	FBCh	CCPR2H	F9Ch	— ⁽²⁾	F7Ch	PTMRH
FFBh	PCLATU	FDBh	PLUSW2 ⁽¹⁾	FBHh	CCPR2L	F9Bh	OSCTUNE	F7Bh	PTPERL
FFAh	PCLATH	FDAh	FSR2H	FBAh	CCP2CON	F9Ah	ADCON3	F7Ah	PTPERH
FF9h	PCL	FD9h	FSR2L	FB9h	ANSEL1	F99h	ADCHS	F79h	PDC0L
FF8h	TBLPTRU	FD8h	STATUS	FB8h	ANSEL0	F98h	— ⁽²⁾	F78h	PDC0H
FF7h	TBLPTRH	FD7h	TMR0H	FB7h	T5CON	F97h	— ⁽²⁾	F77h	PDC1L
FF6h	TBLPTRL	FD6h	TMR0L	FB6h	QEICON	F96h	TRISE ⁽³⁾	F76h	PDC1H
FF5h	TABLAT	FD5h	T0CON	FB5h	— ⁽²⁾	F95h	TRISD ⁽³⁾	F75h	PDC2L
FF4h	PRODH	FD4h	— ⁽²⁾	FB4h	— ⁽²⁾	F94h	TRISC	F74h	PDC2H
FF3h	PRODL	FD3h	OSCCON	FB3h	— ⁽²⁾	F93h	TRISB	F73h	PDC3L ⁽³⁾
FF2h	INTCON	FD2h	LVDCON	FB2h	— ⁽²⁾	F92h	TRISA	F72h	PDC3H ⁽³⁾
FF1h	INTCON2	FD1h	WDTCON	FB1h	— ⁽²⁾	F91h	PR5H	F71h	SEVTCMPL
FF0h	INTCON3	FD0h	RCON	FB0h	SPBRGH	F90h	PR5L	F70h	SEVTCMPH
FEFh	INDF0 ⁽¹⁾	FCFh	TMR1H	FAFh	SPBRG	F8Fh	— ⁽²⁾	F6Fh	PWMCON0
FEeh	POSTINC0 ⁽¹⁾	FCEh	TMR1L	FAeh	RCREG	F8Eh	— ⁽²⁾	F6Eh	PWMCON1
FEDh	POSTDEC0 ⁽¹⁾	FCDh	T1CON	FADh	TXREG	F8Dh	LATE ⁽³⁾	F6Dh	DTCON
FECh	PREINC0 ⁽¹⁾	FCCh	TMR2	FACH	TXSTA	F8Ch	LATD ⁽³⁾	F6Ch	FLTCONFIG
FEBh	PLUSW0 ⁽¹⁾	FCBh	PR2	FABh	RCSTA	F8Bh	LATC	F6Bh	OVDCOND
FEAh	FSR0H	FCAh	T2CON	FAAh	BAUDCON	F8Ah	LATB	F6Ah	OVDCONS
FE9h	FSR0L	FC9h	SSPBUF	FA9h	EEADR	F89h	LATA	F69h	CAP1BUFH
FE8h	WREG	FC8h	SSPADD	FA8h	EEDATA	F88h	TMR5H	F68h	CAP1BUFL
FE7h	INDF1 ⁽¹⁾	FC7h	SSPSTAT	FA7h	EECON2	F87h	TMR5L	F67h	CAP2BUFH
FE6h	POSTINC1 ⁽¹⁾	FC6h	SSPCON	FA6h	EECON1	F86h	— ⁽²⁾	F66h	CAP2BUFL
FE5h	POSTDEC1 ⁽¹⁾	FC5h	— ⁽²⁾	FA5h	IPR3	F85h	— ⁽²⁾	F65h	CAP3BUFH
FE4h	PREINC1 ⁽¹⁾	FC4h	ADRESH	FA4h	PIR3	F84h	PORTE	F64h	CAP3BUFL
FE3h	PLUSW1 ⁽¹⁾	FC3h	ADRESL	FA3h	PIE3	F83h	PORTD ⁽³⁾	F63h	CAP1CON
FE2h	FSR1H	FC2h	ADCON0	FA2h	IPR2	F82h	PORTC	F62h	CAP2CON
FE1h	FSR1L	FC1h	ADCON1	FA1h	PIR2	F81h	PORTB	F61h	CAP3CON
FE0h	BSR	FC0h	ADCON2	FA0h	PIE2	F80h	PORTA	F60h	DFLTCON

Note 1: This is not a physical register.

2: Unimplemented registers are read as ‘0’.

3: This register is not available on 28-pin devices.

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REGISTER 10-6: PIR3: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 3

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	PTIF	IC3DRIF	IC2QEIF	IC1IF	TMR5IF
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **PTIF:** PWM Time Base Interrupt bit

1 = PWM time base matched the value in the PTPER registers. Interrupt is issued according to the postscaler settings. PTIF must be cleared in software.

0 = PWM time base has not matched the value in the PTPER registers

bit 3 **IC3DRIF:** IC3 Interrupt Flag/Direction Change Interrupt Flag bit

IC3 Enabled (CAP3CON<3:0>):

1 = TMR5 value was captured by the active edge on CAP3 input (must be cleared in software)

0 = TMR5 capture has not occurred

QE1 Enabled (QEIM<2:0>):

1 = Direction of rotation has changed (must be cleared in software)

0 = Direction of rotation has not changed

bit 2 **IC2QEIF:** IC2 Interrupt Flag/QE1 Interrupt Flag bit

IC2 Enabled (CAP2CON<3:0>):

1 = TMR5 value was captured by the active edge on CAP2 input (must be cleared in software)

0 = TMR5 capture has not occurred

QE1 Enabled (QEIM<2:0>):

1 = The QE1 position counter has reached the MAXCNT value, or the index pulse, INDX, has been detected. Depends on the QE1 operating mode enabled. Must be cleared in software.

0 = The QE1 position counter has not reached the MAXCNT value or the index pulse has not been detected

bit 1 IC1 Enabled (CAP1CON<3:0>):

1 = TMR5 value was captured by the active edge on CAP1 input (must be cleared in software)

0 = TMR5 capture has not occurred

QE1 Enabled (QEIM<2:0>), Velocity Measurement Mode Enabled ($\overline{\text{VELM}} = 0$ in QEICON register):

1 = Timer5 value was captured by the active velocity edge (based on PHA or PHB input). CAP1REN bit must be set in CAP1CON register. IC1IF must be cleared in software.

0 = Timer5 value was not captured by the active velocity edge

bit 0 **TMR5IF:** Timer5 Interrupt Flag bit

1 = Timer5 time base matched the PR5 value (must be cleared in software)

0 = Timer5 time base did not match the PR5 value

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TABLE 11-3: PORTB I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RB0/PWM0	RB0	0	O	DIG	LATB<0> data output; not affected by analog input.
		1	I	TTL	PORTB<0> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.
	PWM0	0	O	DIG	PWM Output 0.
RB1/PWM1	RB1	0	O	DIG	LATB<1> data output; not affected by analog input.
		1	I	TTL	PORTB<1> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.
	PWM1	0	O	DIG	PWM Output 1.
RB2/PWM2	RB2	0	O	DIG	LATB<2> data output; not affected by analog input.
		1	I	TTL	PORTB<2> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.
	PWM2	0	O	DIG	PWM Output 2.
RB3/PWM3	RB3	0	O	DIG	LATB<3> data output; not affected by analog input.
		1	I	TTL	PORTB<3> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.
	PWM3	0	O	DIG	PWM Output 3.
RB4/KBI0/PWM5	RB4	0	O	DIG	LATB<4> data output; not affected by analog input.
		1	I	TTL	PORTB<4> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.
	KBI0	1	I	TTL	Interrupt-on-change pin.
	PWM5	0	O	DIG	PWM Output 5.
RB5/KBI1/PWM4/PGM	RB5	0	O	DIG	LATB<5> data output.
		1	I	TTL	PORTB<5> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared.
	KBI1	1	I	TTL	Interrupt-on-change pin.
	PWM4 ⁽³⁾	0	O	DIG	PWM Output 4; takes priority over port data.
	PGM ⁽²⁾	x	I	ST	Single-Supply Programming mode entry (ICSP™). Enabled by LVP Configuration bit; all other pin functions are disabled.
RB6/KBI2/PGC	RB6	0	O	DIG	LATB<6> data output.
		1	I	TTL	PORTB<6> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared.
	KBI2	1	I	TTL	Interrupt-on-change pin.
	PGC	x	I	ST	Serial execution (ICSP™) clock input for ICSP and ICD operation. ⁽¹⁾
RB7/KBI3/PGD	RB7	0	O	DIG	LATB<7> data output.
		1	I	TTL	PORTB<7> data input; weak pull-up when $\overline{\text{RBPU}}$ bit is cleared.
	KBI3	1	I	TTL	Interrupt-on-change pin.
	PGD	x	O	DIG	Serial execution data output for ICSP and ICD operation. ⁽¹⁾
		x	I	ST	Serial execution data input for ICSP and ICD operation. ⁽¹⁾

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: All other pin functions are disabled when ICSP or ICD is enabled.

2: Single-Supply Programming must be enabled.

3: RD5 is the alternate pin for PWM4.

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NOTES:

16.5 PWM Mode

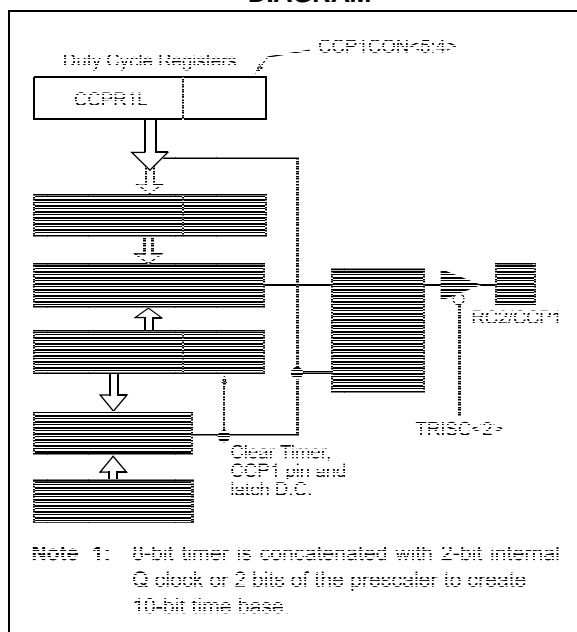
In Pulse-Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 16-3 shows a simplified block diagram of the CCP1 module in PWM mode.

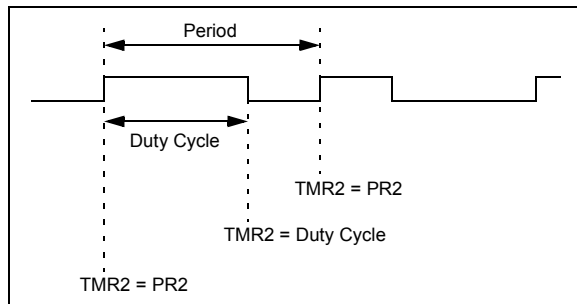
For a step-by-step procedure on how to set up the CCP1 module for PWM operation, see **Section 16.5.3 “Setup for PWM Operation”**.

FIGURE 16-3: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 16-4) has a time base (period) and a time that the output is high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 16-4: PWM OUTPUT



16.5.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following equation:

EQUATION 16-1:

$$\text{PWM Period} = [(PR2) + 1] \cdot 4 \cdot T_{osc} \cdot (\text{TMR2 Prescale Value})$$

PWM frequency is defined as $1/[\text{PWM period}]$. When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is copied from CCPR1L into CCPR1H

Note: The Timer2 postscaler (see **Section 14.0 “Timer2 Module”**) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

16.5.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSBs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The PWM duty cycle is calculated by the following equation:

EQUATION 16-2:

$$\text{PWM Duty Cycle} = (\text{CCPR1L:CCP1CON<5:4>}) \cdot T_{osc} \cdot (\text{TMR2 Prescale Value})$$

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not copied into CCPR1H until a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

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REGISTER 18-4: PWMCON1: PWM CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
SEVOPS3	SEVOPS2	SEVOPS1	SEVOPS0	SEVTDIR	—	UDIS	OSYNC
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7-4 **SEVOPS<3:0>**: PWM Special Event Trigger Output Postscale Select bits

0000 = 1:1 Postscale

0001 = 1:2 Postscale

.

.

.

1111 = 1:16 Postscale

bit 3 **SEVTDIR**: Special Event Trigger Time Base Direction bit

1 = A Special Event Trigger will occur when the PWM time base is counting downwards

0 = A Special Event Trigger will occur when the PWM time base is counting upwards

bit 2 **Unimplemented**: Read as '0'

bit 1 **UDIS**: PWM Update Disable bit

1 = Updates from Duty Cycle and Period Buffer registers are disabled

0 = Updates from Duty Cycle and Period Buffer registers are enabled

bit 0 **OSYNC**: PWM Output Override Synchronization bit

1 = Output overrides via the OVDCON register are synchronized to the PWM time base

0 = Output overrides via the OVDCON register are asynchronous

18.3.1 FREE-RUNNING MODE

In the Free-Running mode, the PWM Time Base registers (PTMRL and PTMRH) will begin counting upwards until the value in the PWM Time Base Period register, PTPER (PTPERL and PTPERH), is matched. The PTMR registers will be reset on the following input clock edge and the time base will continue counting upwards as long as the PTEN bit remains set.

18.3.2 SINGLE-SHOT MODE

In the Single-Shot mode, the PWM time base will begin counting upwards when the PTEN bit is set. When the value in the PTMR register matches the PTPER register, the PTMR register will be reset on the following input clock edge and the PTEN bit will be cleared by the hardware to halt the time base.

18.3.3 CONTINUOUS UP/DOWN COUNT MODES

In Continuous Up/Down Count modes, the PWM time base counts upwards until the value in the PTPER register matches with the PTMR register. On the following input clock edge, the timer counts downwards. The PTDIR bit in the PTCON1 register is read-only and indicates the counting direction. The PTDIR bit is set when the timer counts downwards.

Note: Since the PWM compare outputs are driven to the active state when the PWM time base is counting downwards and matches the duty cycle value, the PWM outputs are held inactive during the first half of the first period of the Continuous Up/Down Count mode until PTMR begins to count down from the PTPER value.

18.3.4 PWM TIME BASE PRESCALER

The input clock to PTMR ($F_{osc}/4$) has prescaler options of 1:1, 1:4, 1:16 or 1:64. These are selected by control bits, PTCKPS<1:0>, in the PTCON0 register. The prescaler counter is cleared when any of the following occurs:

- Write to the PTMR register
- Write to the PTCON (PTCON0 or PTCON1) register
- Any device Reset

Note: The PTMR register is not cleared when PTCONx is written.

19.0 SYNCHRONOUS SERIAL PORT (SSP) MODULE

19.1 SSP Module Overview

The Synchronous Serial Port (SSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C™)

An overview of I²C operations and additional information on the SSP module can be found in the *"PIC® Mid-Range MCU Family Reference Manual"* (DS33023).

Refer to application note AN578, *"Use of the SSP Module in the I²C™ Multi-Master Environment"* (DS00578).

19.2 SPI Mode

This section contains register definitions and operational characteristics of the SPI module. Additional information on the SPI module can be found in the *"PIC® Mid-Range MCU Family Reference Manual"* (DS33023).

SPI mode allows 8 bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally, a fourth pin may be used when in a Slave mode of operation:

- Slave Select (\overline{SS})

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits in the SSPCON (SSPCON<5:0>) and SSPSTAT<7:6> registers. These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock polarity (Idle state of SCK)
- Clock edge (output data on rising/falling edge of SCK)
- Clock rate (Master mode only)
- Slave Select mode (Slave mode only)

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REGISTER 20-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7	SPEN: Serial Port Enable bit 1 = Serial port enabled 0 = Serial port disabled
bit 6	RX9: 9-Bit Receive Enable bit 1 = Selects 9-bit reception 0 = Selects 8-bit reception
bit 5	SREN: Single Receive Enable bit <u>Asynchronous mode:</u> Don't care. <u>Synchronous mode – Master:</u> 1 = Enables single receive 0 = Disables single receive This bit is cleared after reception is complete. <u>Synchronous mode – Slave:</u> Don't care.
bit 4	CREN: Continuous Receive Enable bit <u>Asynchronous mode:</u> 1 = Enables receiver 0 = Disables receiver <u>Synchronous mode:</u> 1 = Enables continuous receive until enable bit, CREN, is cleared (CREN overrides SREN) 0 = Disables continuous receive
bit 3	ADDEN: Address Detect Enable bit <u>Asynchronous mode 9-Bit (RX9 = 1):</u> 1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set 0 = Disables address detection, all bytes are received and ninth bit can be used as parity bit <u>Asynchronous mode 8-Bit (RX9 = 0):</u> Don't care.
bit 2	FERR: Framing Error bit 1 = Framing error (can be cleared by reading RCREGx register and receiving next valid byte) 0 = No framing error
bit 1	OERR: Overrun Error bit 1 = Overrun error (can be cleared by clearing bit, CREN) 0 = No overrun error
bit 0	RX9D: 9th Bit of Received Data This can be address/data bit or a parity bit and must be calculated by user firmware.

20.3.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Because of this, the Baud Rate Generator is inactive and a proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RX/DT line, while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCON<1>). Once set, the typical receive sequence on RX/DT is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RX/DT line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN/J2602 protocol.)

Following a wake-up event, the module generates an RCIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 20-7), and asynchronously if the device is in Sleep mode (Figure 20-8). The interrupt condition is cleared by reading the RCREG register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RX line following the wake-up event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

20.3.4.1 Special Considerations Using Auto-Wake-up

Since Auto-Wake-up functions by sensing rising edge transitions on RX/DT, information with any state changes before the Stop bit may signal a false end-of-character

and cause data or framing errors. To work properly, therefore, the initial characters in the transmission must be all '0's. This can be 00h (8 bits) for standard RS-232 devices, or 000h (12 bits) for LIN/J2602 bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., LP, XT or HS/PLL mode). The Sync Break (or Wake-up Signal) character must be of sufficient length, and be followed by a sufficient interval, to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

20.3.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCIF bit. The WUE bit is cleared after this when a rising edge is seen on RX/DT. The interrupt condition is then cleared by reading the RCREG register. Ordinarily, the data in RCREG will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set), and the RCIF flag is set, should not be used as an indicator of the integrity of the data in RCREG. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCIDL bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 20-7: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

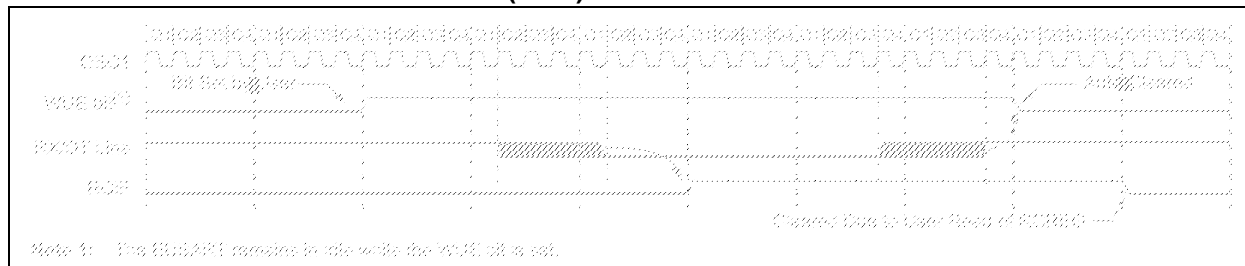
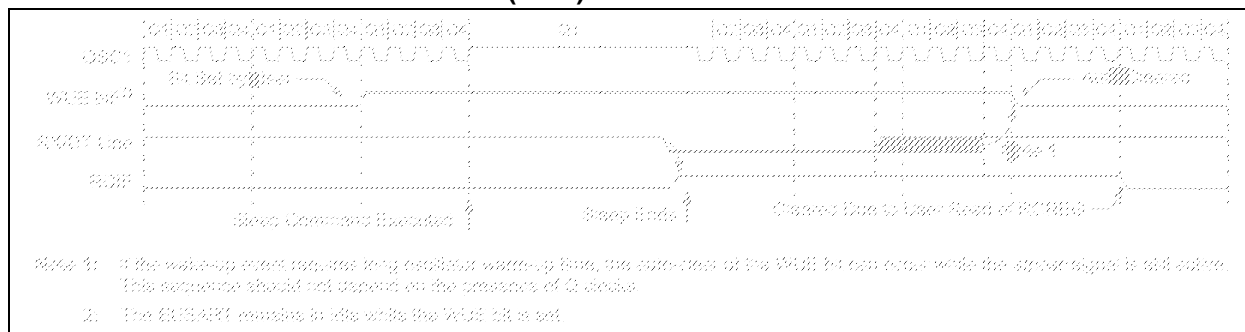


FIGURE 20-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



21.4 A/D Voltage References

If external voltage references are used instead of the internal AVDD and AVSS sources, the source impedance of the VREF+ and VREF- voltage sources must be considered. During acquisition, currents supplied by these sources are insignificant. However, during conversion, the A/D module sinks and sources current through the reference sources.

In order to maintain the A/D accuracy, the voltage reference source impedances should be kept low to reduce voltage changes. These voltage changes occur as reference currents flow through the reference source impedance.

Note: When using external references, the source impedance of the external voltage references must be less than 75Ω in order to achieve the specified ADC resolution. A higher reference source impedance will increase the ADC offset and gain errors. Resistive voltage dividers will not provide a low enough source impedance. To ensure the best possible ADC performance, external VREF inputs should be buffered with an op amp or other low-impedance circuit.

21.5 Selecting and Configuring Automatic Acquisition Time

The ADCON2 register allows the user to select an acquisition time that occurs each time an A/D conversion is triggered.

When the GO/DONE bit is set, sampling is stopped and a conversion begins. The user is responsible for ensuring the required acquisition time has passed between selecting the desired input channel and the start of conversion. This occurs when the ACQT<3:0> bits (ADCON2<6:3>) remain in their Reset state ('0000').

If desired, the ACQT bits can be set to select a programmable acquisition time for the A/D module. When triggered, the A/D module continues to sample the input for the selected acquisition time, then automatically begins a conversion. Since the acquisition time is programmed, there may be no need to wait for an acquisition time between selecting a channel and triggering the A/D. If an acquisition time is programmed, there is nothing to indicate if the acquisition time has ended or if the conversion has begun.

21.6 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 12 TAD per 10-bit conversion. The source of the A/D conversion clock is software selectable. There are eight possible options for TAD:

- 2 TOSC
- 4 TOSC
- 8 TOSC
- 16 TOSC
- 32 TOSC
- 64 TOSC
- Internal RC Oscillator
- Internal RC Oscillator/4

For correct A/D conversions, the A/D conversion clock (TAD) must be as short as possible, but greater than the minimum TAD (approximately 416 ns, see parameter A11 for more information).

Table 21-2 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 21-2: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock Source (TAD)		Maximum Device Frequency	
Operation	ADCS<2:0>	PIC18FXX31	PIC18LFX31 ⁽⁴⁾
2 TOSC	000	4.8 MHz	666 kHz
4 TOSC	100	9.6 MHz	1.33 MHz
8 TOSC	001	19.2 MHz	2.66 MHz
16 TOSC	101	38.4 MHz	5.33 MHz
32 TOSC	010	40.0 MHz	10.65 MHz
64 TOSC	110	40.0 MHz	21.33 MHz
RC/4 ⁽³⁾	011	1.00 MHz ⁽¹⁾	1.00 MHz ⁽²⁾
RC ⁽³⁾	111	4.0 MHz ⁽²⁾	4.0 MHz ⁽²⁾

- Note 1:** The RC source has a typical TAD time of 2-6 μ s.
Note 2: The RC source has a typical TAD time of 0.5-1.5 μ s.
Note 3: For device frequencies above 1 MHz, the device must be in Sleep for the entire conversion or the A/D accuracy may be out of specification unless in Single-Shot mode.
Note 4: Low-power devices only.

PIC18F2331/2431/4331/4431

TABLE 24-1: OPCODE FIELD DESCRIPTIONS

Field	Description
a	RAM access bit: a = 0: RAM location in Access RAM (BSR register is ignored) a = 1: RAM bank is specified by BSR register
bbb	Bit address within an 8-bit file register (0 to 7).
BSR	Bank Select Register. Used to select the current RAM bank.
d	Destination select bit: d = 0: store result in WREG d = 1: store result in file register f
dest	Destination either the WREG register or the specified register file locations.
f	8-bit register file address (0x00 to 0xFF).
fs	12-bit register file address (0x000 to 0xFFF). This is the source address.
fd	12-bit register file address (0x000 to 0xFFF). This is the destination address.
k	Literal field, constant data or label (may be either an 8-bit, 12-bit or a 20-bit value).
label	Label name.
mm	The mode of the TBLPTR register for the table read and table write instructions. Only used with table read and table write instructions:
*	No Change to register (such as TBLPTR with table reads and writes).
*+	Post-Increment register (such as TBLPTR with table reads and writes).
*-	Post-Decrement register (such as TBLPTR with table reads and writes).
++	Pre-Increment register (such as TBLPTR with table reads and writes).
n	The relative address (2's complement number) for relative branch instructions, or the direct address for Call/Branch and Return instructions.
PRODH	Product of Multiply High Byte.
PRODL	Product of Multiply Low Byte.
s	Fast Call/Return Mode Select bit: s = 0: do not update into/from Shadow registers s = 1: certain registers loaded into/from shadow registers (Fast mode)
u	Unused or Unchanged.
WREG	Working register (accumulator).
x	Don't care ('0' or '1'). The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
TBLPTR	21-bit Table Pointer (points to a Program Memory location).
TABLAT	8-bit Table Latch.
TOS	Top-of-Stack.
PC	Program Counter.
PCL	Program Counter Low Byte.
PCH	Program Counter High Byte.
PCLATH	Program Counter High Byte Latch.
PCLATU	Program Counter Upper Byte Latch.
GIE	Global Interrupt Enable bit.
WDT	Watchdog Timer.
TO	Time-out bit.
PD	Power-Down bit.
C, DC, Z, OV, N	ALU Status bits: Carry, Digit Carry, Zero, Overflow, Negative.
[]	Optional.
()	Contents.
→	Assigned to.
< >	Register bit field.
∈	In the set of.
<i>italics</i>	User-defined term (font is Courier New).

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TABLE 24-2: PIC18FXXXX INSTRUCTION SET (CONTINUED)

Mnemonic, Operands		Description	Cycles	16-Bit Instruction Word				Status Affected	Notes
				MSb		LSb			
CONTROL OPERATIONS									
BC	n	Branch if Carry	1 (2)	1110	0010	nnnn	nnnn	None	4
BN	n	Branch if Negative	1 (2)	1110	0110	nnnn	nnnn	None	
BNC	n	Branch if Not Carry	1 (2)	1110	0011	nnnn	nnnn	None	
BNN	n	Branch if Not Negative	1 (2)	1110	0111	nnnn	nnnn	None	
BN OV	n	Branch if Not Overflow	1 (2)	1110	0101	nnnn	nnnn	None	
BNZ	n	Branch if Not Zero	2	1110	0001	nnnn	nnnn	None	
BOV	n	Branch if Overflow	1 (2)	1110	0100	nnnn	nnnn	None	
BRA	n	Branch Unconditionally	1 (2)	1101	0nnn	nnnn	nnnn	None	
BZ	n	Branch if Zero	1 (2)	1110	0000	nnnn	nnnn	None	
CALL	n, s	Call Subroutine 1st word	2	1110	110s	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
CLRWDT	—	Clear Watchdog Timer	1	0000	0000	0000	0100	$\overline{\text{TO}}, \overline{\text{PD}}$	
DAW	—	Decimal Adjust WREG	1	0000	0000	0000	0111	C, DC	
GOTO	n	Go to Address 1st word	2	1110	1111	kkkk	kkkk	None	
		2nd word		1111	kkkk	kkkk	kkkk		
NOP	—	No Operation	1	0000	0000	0000	0000	None	
NOP	—	No Operation	1	1111	xxxx	xxxx	xxxx	None	
POP	—	Pop Top of Return Stack (TOS)	1	0000	0000	0000	0110	None	
PUSH	—	Push Top of Return Stack (TOS)	1	0000	0000	0000	0101	None	
RCALL	n	Relative Call	2	1101	1nnn	nnnn	nnnn	None	
RESET		Software Device Reset	1	0000	0000	1111	1111	All	
RETFIE	s	Return from Interrupt Enable	2	0000	0000	0001	000s	GIE/GIEH, PEIE/GIEL	
RETLW	k	Return with Literal in WREG	2	0000	1100	kkkk	kkkk	None	
RETURN	s	Return from Subroutine	2	0000	0000	0001	001s	None	
SLEEP	—	Go into Standby mode	1	0000	0000	0000	0011	$\overline{\text{TO}}, \overline{\text{PD}}$	

- Note 1:** When a PORT register is modified as a function of itself (e.g., `MOVF PORTB, 1, 0`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as an input and is driven low by an external device, the data will be written back with a '0'.
- 2:** If this instruction is executed on the TMR0 register (and, where applicable, $d = 1$), the prescaler will be cleared if assigned.
- 3:** If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.
- 4:** Some instructions are 2-word instructions. The second word of these instructions will be executed as a `NOP` unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.
- 5:** If the table write starts the write cycle to internal memory, the write will continue until terminated.

PIC18F2331/2431/4331/4431

LFSR

Load FSR

Syntax: `[label] LFSR f,k`

Operands: $0 \leq f \leq 2$
 $0 \leq k \leq 4095$

Operation: $k \rightarrow \text{FSRf}$

Status Affected: None

Encoding:

1110	1110	00ff	k ₁₁ kkk
1111	0000	k ₇ kkk	kkkk

Description: The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k' MSB	Process Data	Write literal 'k' MSB to FSRfH
Decode	Read literal 'k' LSB	Process Data	Write literal 'k' to FSRfL

Example: LFSR 2, 0x3AB

After Instruction
 FSR2H = 0x03
 FSR2L = 0xAB

MOVF

Move f

Syntax: `[label] MOVF f[d [,a]]`

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$
 $a \in [0,1]$

Operation: $f \rightarrow \text{dest}$

Status Affected: N, Z

Encoding:

0101	00da	ffff	ffff
------	------	------	------

Description: The contents of register, 'f', are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register, 'f'. Location, 'f', can be anywhere in the 256-byte bank. If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write W

Example: MOVF REG, W

Before Instruction
 REG = 0x22
 W = 0xFF

After Instruction
 REG = 0x22
 W = 0x22

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RETFIE Return from Interrupt

Syntax:	[<i>label</i>] RETFIE [<i>s</i>]				
Operands:	$s \in [0,1]$				
Operation:	(TOS) → PC, 1 → GIE/GIEH or PEIE/GIEL; if $s = 1$: (WS) → W, (STATUSS) → STATUS, (BSRS) → BSR, PCLATU, PCLATH are unchanged				
Status Affected:	GIE/GIEH, PEIE/GIEL.				
Encoding:	<table border="1"><tr><td>0000</td><td>0000</td><td>0001</td><td>000s</td></tr></table>	0000	0000	0001	000s
0000	0000	0001	000s		
Description:	Return from interrupt. Stack is popped and Top-of-Stack (TOS) is loaded into the PC. Interrupts are enabled by setting either the high or low-priority global interrupt enable bit. If 's' = 1, the contents of the shadow registers, WS, STATUSS and BSRS, are loaded into their corresponding registers, W, STATUS and BSR. If 's' = 0, no update of these registers occurs.				
Words:	1				
Cycles:	2				
Q Cycle Activity:					

Example: RETFIE 1

After Interrupt	
PC	= TOS
W	= WS
BSR	= BSRS
STATUS	= STATUSS
GIE/GIEH, PEIE/GIEL	= 1

RETLW Return Literal to W

Syntax:	[<i>label</i>] RETLW k			
Operands:	$0 \leq k \leq 255$			
Operation:	$k \rightarrow W$, (TOS) \rightarrow PC, PCLATU, PCLATH are unchanged			
Status Affected:	None			
Encoding:	0000	1100	kkkk	kkkk
Description:	W is loaded with the 8-bit literal, 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged.			
Words:	1			
Cycles:	2			
Q Cycle Activity:				
	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process Data	POP PC from stack, Write to W
	No operation	No operation	No operation	No operation

Example:

```
CALL TABLE ; W contains table
              ; offset value
              ; W now has
              ; table value
:
TABLE
  ADDWF PCL ; W = offset
  RETLW k0 ; Begin table
  RETLW k1 ;
:
  RETLW kn ; End of table
```

Before Instruction

W = 0x07

After Instruction

W = value of kn

PIC18F2331/2431/4331/4431

26.2 DC Characteristics: Power-Down and Supply Current

PIC18F2331/2431/4331/4431 (Industrial, Extended)

PIC18LF2331/2431/4331/4431 (Industrial) (Continued)

PIC18LF2331/2431/4331/4431 (Industrial)			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
PIC18F2331/2431/4331/4431 (Industrial, Extended)			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param No.	Device	Typ	Max	Units	Conditions		
	Supply Current (IDD) ^(2,3)						
	PIC18LF2X31/4X31	5.1	9	μA	-10°C	VDD = 2.0V	FOSC = 32 kHz ⁽⁴⁾ (SEC_RUN mode, Timer1 as clock)
		5.8	9	μA	+25°C		
		7.9	11	μA	+70°C		
	PIC18LF2X31/4X31	7.9	12	μA	-10°C	VDD = 3.0V	
		8.9	12	μA	+25°C		
		10.5	14	μA	+70°C		
	All devices	12.5	20	μA	-10°C	VDD = 5.0V	
		16.3	20	μA	+25°C		
		18.9	25	μA	+70°C		
		150	850	μA	+125°C		
	PIC18LF2X31/4X31	9.2	15	μA	-10°C	VDD = 2.0V	FOSC = 32 kHz ⁽⁴⁾ (SEC_IDLE mode, Timer1 as clock)
		9.6	15	μA	+25°C		
		12.7	18	μA	+70°C		
	PIC18LF2X31/4X31	22.0	30	μA	-10°C	VDD = 3.0V	
		21.0	30	μA	+25°C		
		20.0	35	μA	+70°C		
	All devices	30	80	μA	-10°C	VDD = 5.0V	
		45	80	μA	+25°C		
		45	85	μA	+70°C		
250		850	μA	+125°C			

Legend: Shading of rows is to assist in readability of the table.

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or VSS, and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

MCLR = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula: $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in kΩ.

4: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

PIC18F2331/2431/4331/4431

FIGURE 26-9: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

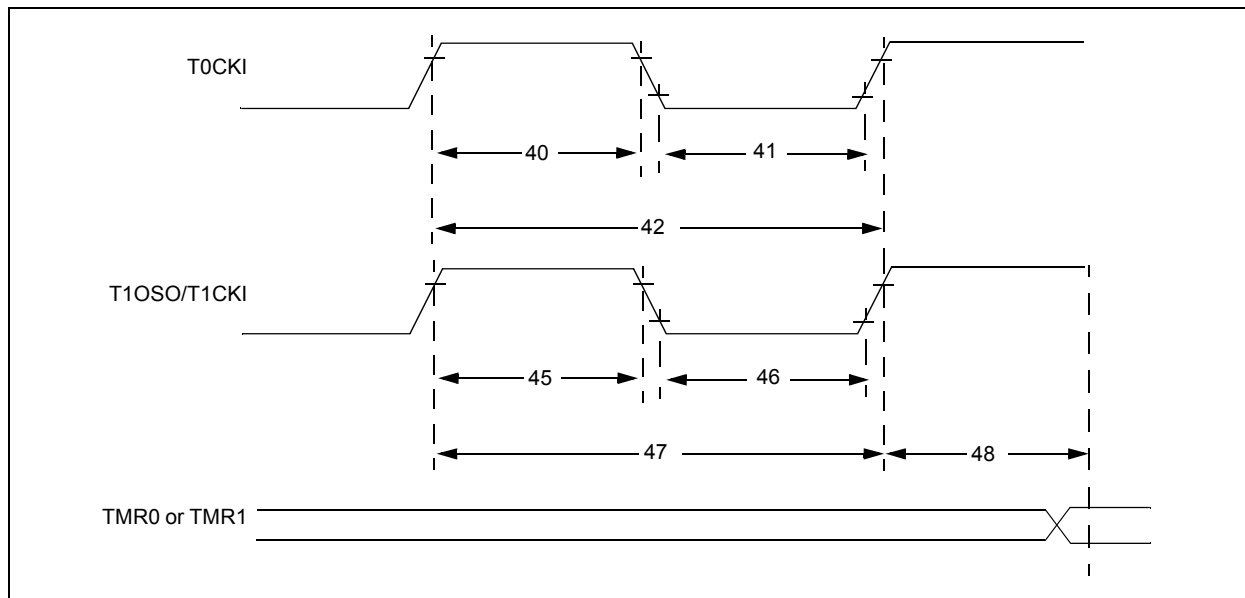


TABLE 26-9: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No prescaler	$0.5 T_{CY} + 20$	—	ns	$V_{DD} = 2V$
			With prescaler	10	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No prescaler	$0.5 T_{CY} + 20$	—	ns	
			With prescaler	10	—	ns	
42	Tt0P	T0CKI Period	No prescaler	$T_{CY} + 10$	—	ns	
			With prescaler	Greater of: $20 \text{ ns or } \frac{T_{CY} + 40}{N}$	—	ns	
45	Tt1H	T1CKI High Time	Synchronous, no prescaler	$0.5 T_{CY} + 20$	—	ns	
			Synchronous, with prescaler	PIC18FXX31	10	—	ns
				PIC18LFXX31	25	—	ns
			Asynchronous	PIC18FXX31	30	—	ns
				PIC18LFXX31	50	—	ns
46	Tt1L	T1CKI Low Time	Synchronous, no prescaler	$0.5 T_{CY} + 5$	—	ns	
			Synchronous, with prescaler	PIC18FXX31	10	—	ns
				PIC18LFXX31	25	—	ns
			Asynchronous	PIC18FXX31	30	—	ns
				PIC18LFXX31	50	—	ns
47	Tt1P	T1CKI Input Period	Synchronous	Greater of: $20 \text{ ns or } \frac{T_{CY} + 40}{N}$	—	ns	$N = \text{prescale value (1, 2, 4, 8)}$
			Asynchronous	60	—	ns	
	Ft1	T1CKI Oscillator Input Frequency Range		DC	50	kHz	
48	Tcke2tmr1	Delay from External T1CKI Clock Edge to Timer Increment		$2 T_{OSC}$	$7 T_{OSC}$	—	

PIC18F2331/2431/4331/4431

FIGURE 26-10: CAPTURE/COMPARE/PWM TIMINGS (ALL CCP MODULES)

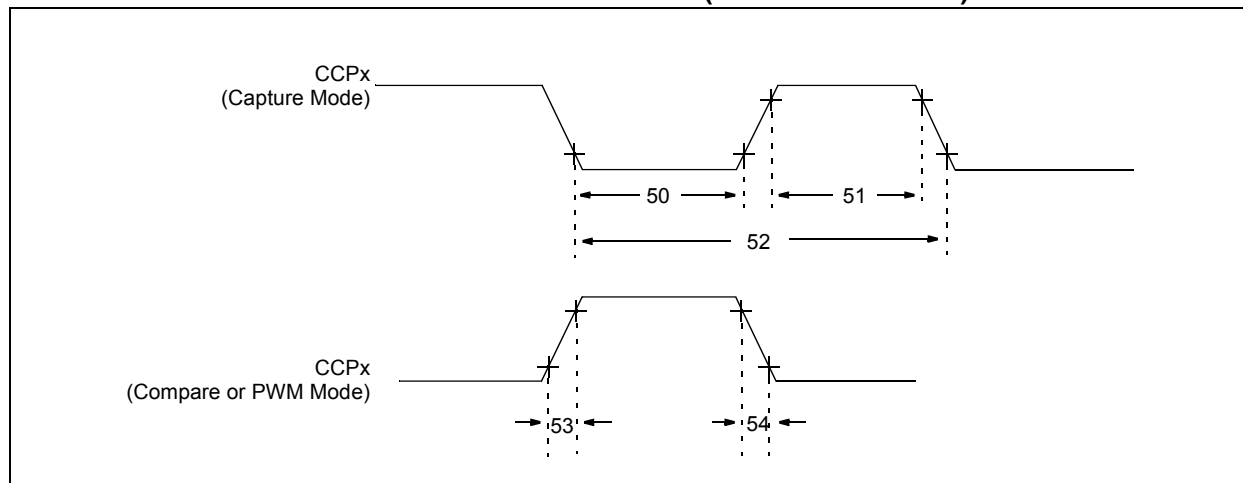


TABLE 26-10: CAPTURE/COMPARE/PWM REQUIREMENTS (ALL CCP MODULES)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions	
50	TccL	CCPx Input Low Time	No prescaler	0.5 Tcy + 20	—	ns		
			With prescaler	PIC18FXX31	10	—		ns
				PIC18LFXX31	20	—		ns
51	TccH	CCPx Input High Time	No prescaler	0.5 Tcy + 20	—	ns		
			With prescaler	PIC18FXX31	10	—		ns
				PIC18LFXX31	20	—		ns
52	TccP	CCPx Input Period		$\frac{3 Tcy + 40}{N}$	—	ns	N = prescale value (1, 4 or 16)	
53	TccR	CCPx Output Fall Time	PIC18FXX31	—	25	ns		
			PIC18LFXX31	—	45	ns		
54	TccF	CCPx Output Fall Time	PIC18FXX31	—	25	ns		
			PIC18LFXX31	—	45	ns		

PIC18F2331/2431/4331/4431

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